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JAN 1 3 2006 Docket No. 60173 (71987)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

APPLICAN'S:

C. Huang

U.S. SERIAL NO:

10/696,198

EXAMINER: H. Trinh

FILED:

October 28, 2003

GROUP:

2814

FOR:

MULTI-CHIP PACKAGE DEVICE WITH HEAT SINK AND

FABRICATION METHOD THEREOF

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted by facsimile to the U.S. Petent & Trademark Office by facsimile number 571-273-8300 on January 13, 2006.

y: Charles M. Tenson

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sit/Madam:

AMENDMENT

Applicants are in receipt of the Office Action dated October 13, 2005 of the above-referenced application. Please amend the application as follows:

Amendments to the specification bogin on page 2 of this paper.

Amendments to the claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 5 of this paper.

7/98/20 0/00/20